CHIPQUIK®

SMD2SWLT.047 2OZ

Datasheet revision 1.0 www.chipquik.com

Sn42/Bi57.6/Ag0.4 .047" Solid Core Solder Wire 2oz Spool

Product Highlights
LOW TEMPERATURE
Melts at 138°C (281°F)
Lead-Free
RoHS III and REACH compliant

Specifications

 Alloy:
 Sn42/Bi57.6/Ag0.4

 Wire diameter:
 0.047" (1.2mm)

 Melting Point:
 138°C (281°F)

 Packaging:
 2oz Spool



Store in a non-corrosive, dry environment.



Please Note: Although Sn42/Bi57.6/Ag0.4 forms strong joints and is more ductile due to the added 0.4% Silver, in wire form it is brittle and needs to be handled gently when unspooling. It is normal for spooled Sn42/Bi57.6/Ag0.4 wire to have some breaks in it.

Test Results

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials

Conforms to the following Industry Standards:

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes RoHS 3 Directive (EU) 2015/863: Yes